

Docket Number  
36856.1455

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants: Hiroyuki KANBARA et al.  Serial No.: Currently unknown  Filing or 371(c) Date: Concurrently herewith  Title: METHOD FOR FORMING THICK FILM PATTERN, METHOD FOR MANUFACTURING ELECTRONIC COMPONENT, AND PHOTOLITHOGRAPHY PHOTOSENSITIVE PASTE	International Application No.: PCT/JP2004/015621   International Filing Date: October 21, 2004
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**PRELIMINARY AMENDMENT**

Mail Stop PCT  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Prior to examination on the merits of the above-identified patent application,  
Applicants respectfully request entry and consideration of the following Amendment:

- ☒ **Amendments to the Specification** begin on page 2 of this paper.
- ☐ **Amendments to the Drawings** begin on page        of this paper and include an attached replacement sheet.
- ☒ **Amendments to the Claims** are reflected in the listing of the claims which begins on page 5 of this paper.
- ☒ **Remarks/Arguments** begin on page 10 of this paper.

Please note, if a box is not checked, then no corresponding amendment is being made.